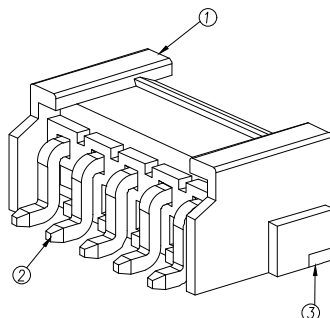
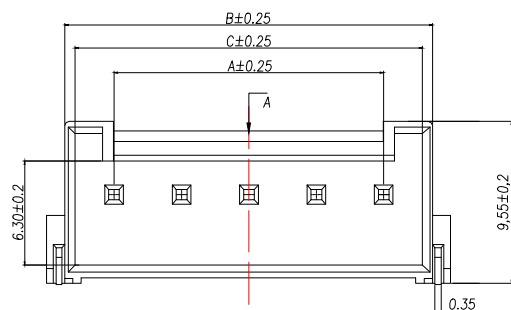
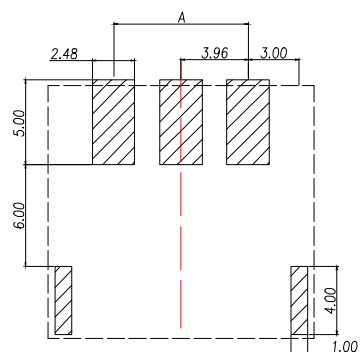
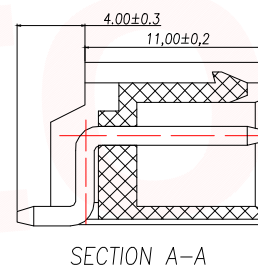
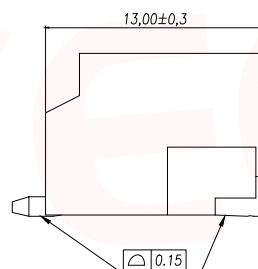
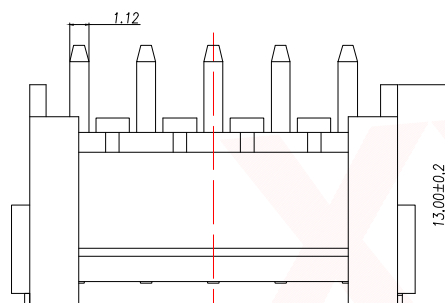
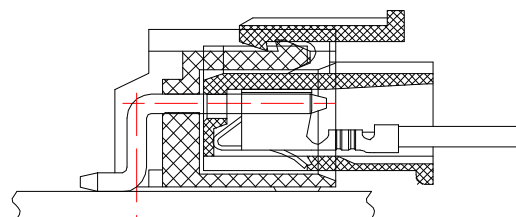




Part No	Pin	A	B	C
XY-VH3.96-2A61	2	3.96	9.80	8.60
XY-VH3.96-3A61	3	7.92	13.76	12.56
XY-VH3.96-4A61	4	11.88	17.72	16.52
XY-VH3.96-5A61	5	15.84	21.68	20.48
XY-VH3.96-6A61	6	19.80	25.64	24.44
XY-VH3.96-7A61	7	23.76	29.60	28.40
XY-VH3.96-8A61	8	27.72	33.56	32.36
XY-VH3.96-9A61	9	31.68	37.52	36.32
XY-VH3.96-10A61	10	35.64	45.44	40.28

技术要求:

1. 塑件材料: LCP(UL-94V-0)
2. 接触件: 黄铜镀锡
3. 接触电阻: $\leq 30m\Omega$
4. 绝缘电阻: $\geq 1000M\Omega$
5. 额定电压: 250V AC DC
6. 额定电流: 7.0A AC DC
7. 耐压: 能承受1000V AC/Minute
8. 工作温度: $-25^{\circ}\sim+85^{\circ}$
9. 可焊性试验: 浸锡面积 $>95\%$ 温度260, 时间 2.5 ± 0.5 秒
10. 铅和铜等六大有害物质含量要符合环保要求。

SUGGESTED PCB LAYOUT
(COMPONENT SIDE)SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

3	焊片 Fitting Nail	黄铜	2	电镀(锡): 整个表面镀底镍 30u"MIN, 再镀锡80u"MIN
2	端子 Contact	黄铜	N*1	电镀(锡): 整个表面镀底镍 30u"MIN, 再镀锡80u"MIN
1	基座 Wafer	LCP (UL94V-0)	1	米色
序号	名称	材料	数量	备注

DIMENSION IN mm		厦门市辛译精密电子有限公司 Xiamen XinYi Xyecom Electronics Co.,Ltd			
TOLERANCE UNLESS OTHERWISE SPECIFIED					
.X±0.35	X.*±5°	APR.	Alex	TITLE: 3.96MM 贴片	
.XX±0.25	.X.*±3°	CHK.	Jack	DWG NO. XY-VH3.96-NA61	
.XXX±0.15	.XX.*±1°	DRA.	Can	PROJ.	CUSTOMER DRAWING
SIZE A4	SCALE 1:1	SHEET 1/1	REV. A		